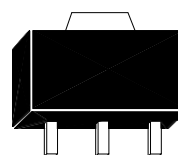


N-Channel Enhancement Mode Power MOSFET

Features:

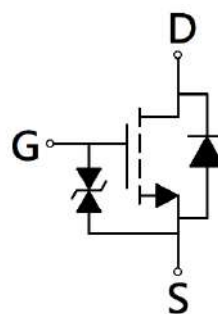
- Low On Resistance
- Low Gate Charge
- Fast Switching Characteristic
- ESD protected gate

SOT-89



G D S

BV_{DSS}	60V
$I_D @ V_{GS}=4.5V, T_A=25^\circ C$	1.9A
$R_{DS(ON)} \text{ typ. @ } V_{GS}=4.5V, I_D=1.5A$	220m Ω
$R_{DS(ON)} \text{ typ. @ } V_{GS}=2.5V, I_D=0.5A$	320m Ω



G : Gate S : Source D : Drain

Ordering Information

Device	Package	Shipping
KMA180N06	SOT-89 (Pb-free lead plating and halogen-free package)	1000 pcs / Tape & Reel

Absolute Maximum Ratings (T_A=25°C)

Parameter		Symbol	Limits	Unit
Drain-Source Voltage		V _{DS}	60	V
Gate-Source Voltage		V _{GS}	±20	
Continuous Drain Current @ V _{GS} =4.5V, T _A =25°C		I _D	1.9	A
Continuous Drain Current @ V _{GS} =4.5V, T _A =70°C			1.5	
Pulsed Drain Current		I _{DM}	7.6	
Continuous Body Diode Forward Current @ T _A =25°C		I _S	1	
Total Power Dissipation	T _A =25°C	P _D	2	W
	T _A =70°C		1.3	
Operating Junction and Storage Temperature Range		T _J , T _{stg}	-55~+150	°C

Thermal Data

Parameter	Symbol	Steady State	Unit
Thermal Resistance, Junction-to-case	R _{θJC}	25	°C/W
Thermal Resistance, Junction-to-ambient	R _{θJA}	62.5	

Note:

*a. The value of R_{θJA} is measured with the device mounted on 1 in² FR -4 board with 2 oz. copper, in a still air environment with T_A=25°C. The power dissipation P_D is based on R_{θJA} and the maximum allowed junction temperature of 150°C. The value in any given application depends on the user's specific board design.

*b. Repetitive rating, pulse width limited by junction temperature T_{J(MAX)}=150°C. Ratings are based on low frequency and low duty cycles to keep initial T_J=25°C.

Electrical Characteristics (T_A=25°C, unless otherwise specified)

Symbol	Min.	Typ.	Max.	Unit	Test Conditions
Static					
BV _{DSS}	60	-	-	V	V _{GS} =0V, I _D =250μA
V _{GS(th)}	0.5	-	1.5		V _{DS} =V _{GS} , I _D =250μA
G _{FS}	-	4.5	-	S	V _{DS} =5V, I _D =5A
I _{GSS}	-	-	±10	μA	V _{GS} =±16V, V _{DS} =0V
I _{DSS}	-	-	1		V _{DS} =48V, V _{GS} =0V
R _{DS(ON)}	-	220	290	mΩ	V _{GS} =4.5V, I _D =1.5A
	-	320	450		V _{GS} =2.5V, I _D =0.5A
Dynamic					
C _{iss}	-	120	-	pF	V _{DS} =30V, V _{GS} =0V, f=1MHz
C _{oss}	-	16	-		
C _{rss}	-	19	-		
R _g	-	3.8	-	Ω	f=1MHz
Q _g *1, 2	-	2	-	nC	V _{DS} =30V, I _D =1.5A, V _{GS} =4.5V
Q _{gs} *1, 2	-	0.7	-		
Q _{gd} *1, 2	-	0.4	-		
t _{d(ON)} *1, 2	-	5.5	-	ns	V _{DS} =30V, I _D =1.5A, V _{GS} =4.5V, R _{GS} =4.7Ω
t _r *1, 2	-	17	-		
t _{d(OFF)} *1, 2	-	11	-		
t _f *1, 2	-	13	-		
Source-Drain Diode					
V _{SD} *1	-	0.83	1.2	V	I _S =1.5A, V _{GS} =0V
t _{rr}	-	7	-	ns	I _F =1.5A, dI _F /dt=100A/μs
Q _{rr}	-	3	-	nC	

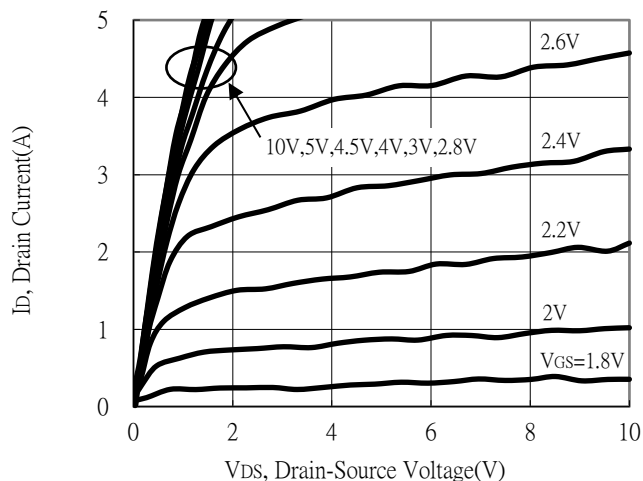
Note:

*1. Pulse Test : Pulse Width ≤300μs, Duty Cycle≤2%

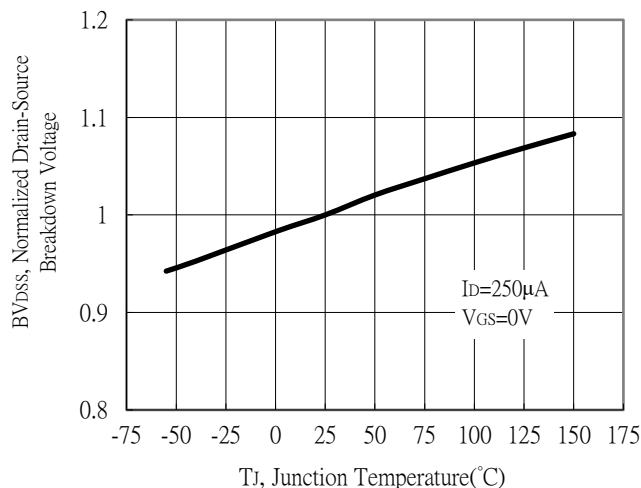
*2. Independent of operating temperature

Typical Characteristics

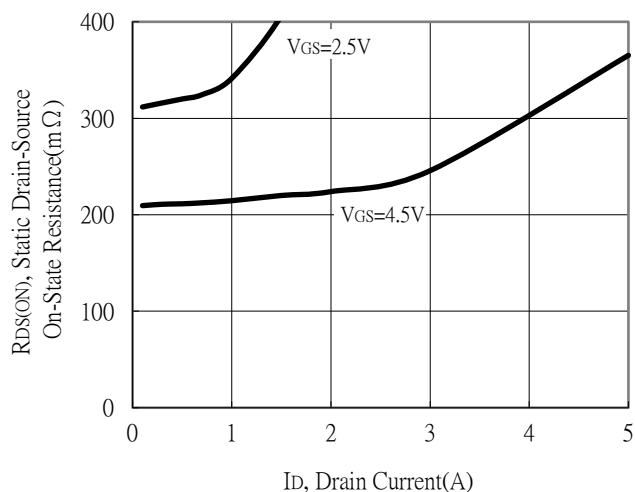
Typical Output Characteristics



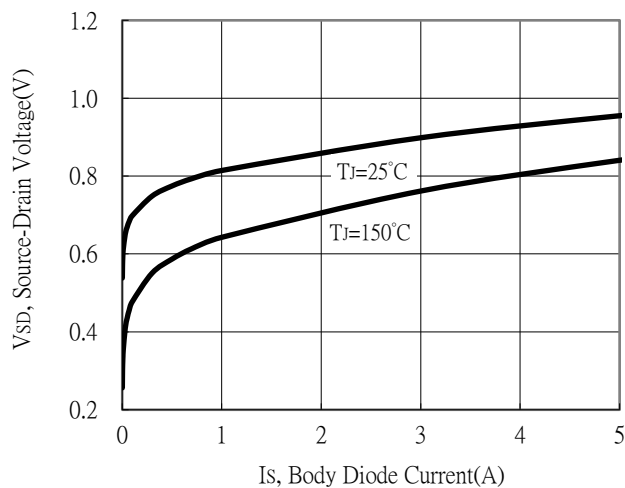
Breakdown Voltage vs Ambient Temperature



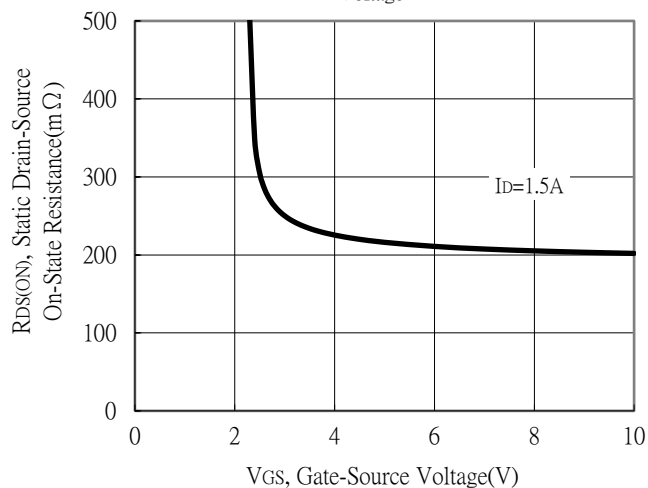
Static Drain-Source On-State resistance vs Drain Current



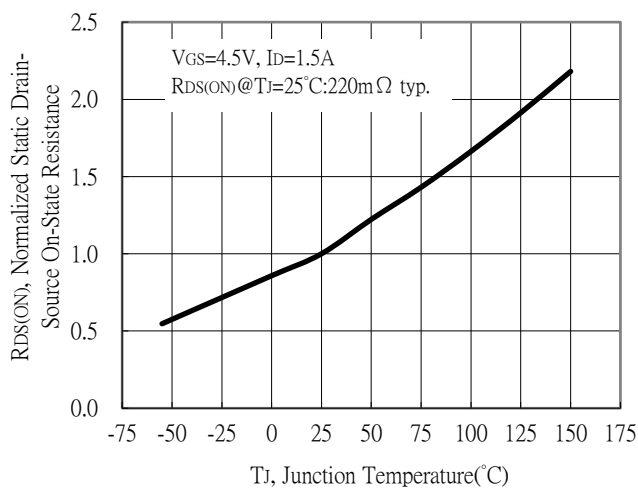
Body Diode Current vs Source-Drain Voltage



Static Drain-Source On-State Resistance vs Gate-Source Voltage

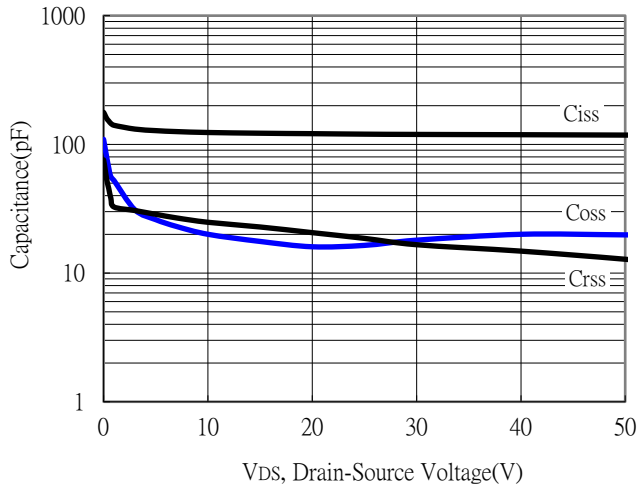


Drain-Source On-State Resistance vs Junction Temperature

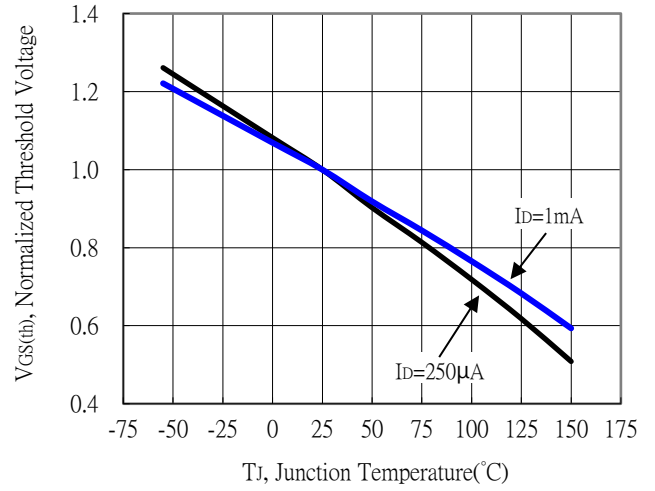


Typical Characteristics (Cont.)

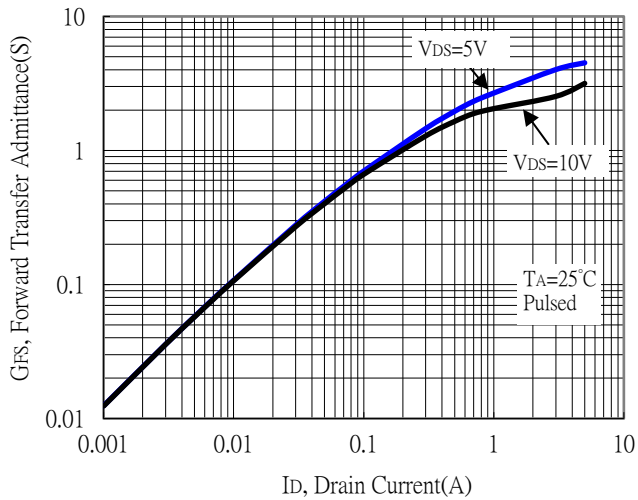
Capacitance vs Drain-to-Source Voltage



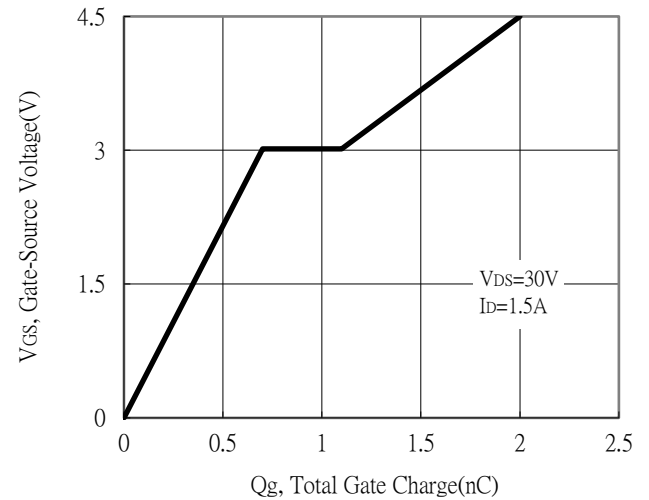
Threshold Voltage vs Junction Temperature



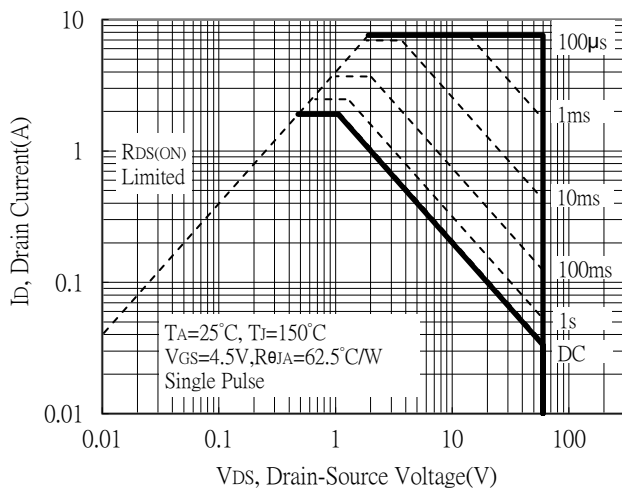
Forward Transfer Admittance vs Drain Current



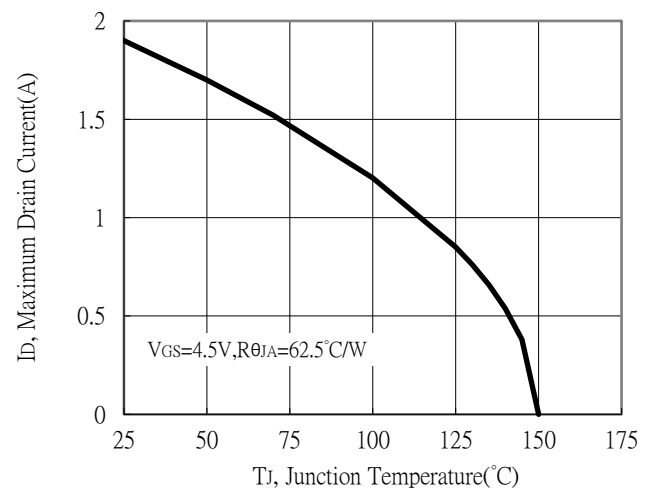
Gate Charge Characteristics



Maximum Safe Operating Area

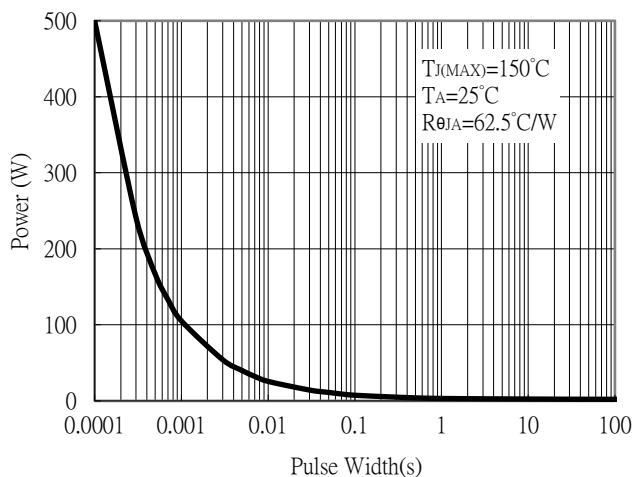


Maximum Drain Current vs Junction Temperature

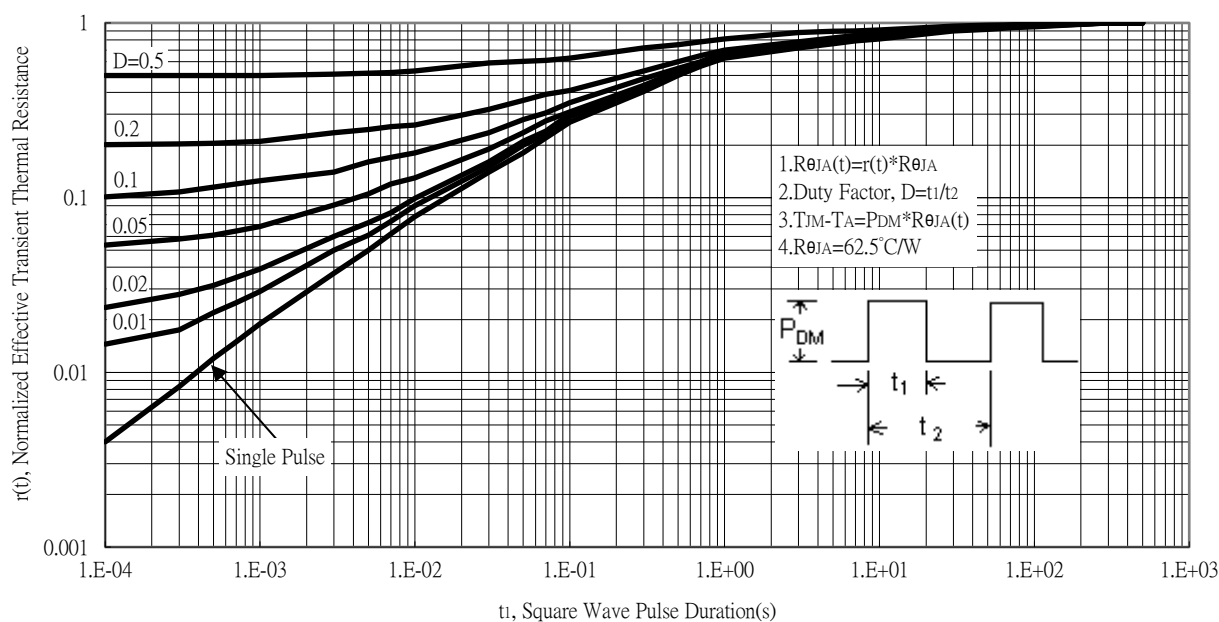


Typical Characteristics (Cont.)

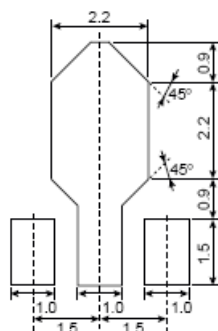
Single Pulse Power Rating, Junction to Ambient



Transient Thermal Response Curves

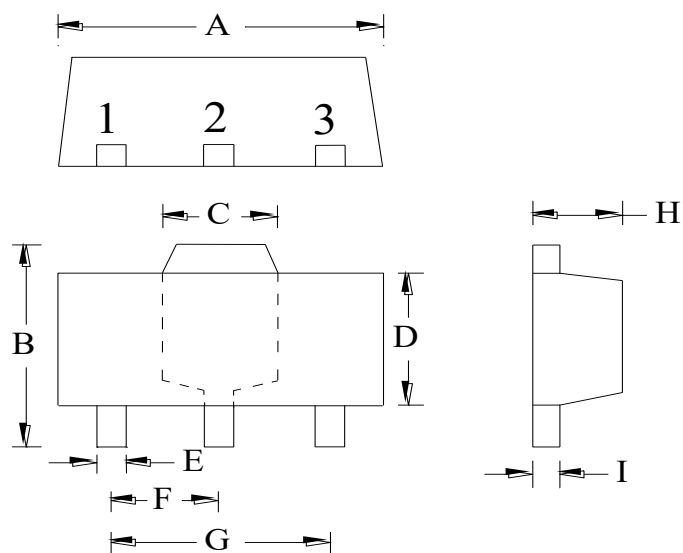


Recommended Soldering Footprint



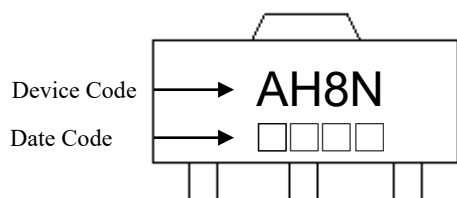
unit : mm

SOT-89 Dimension



3-Lead SOT-89 Plastic
Surface Mounted Package

Marking:



Style: Pin 1. Gate 2. Drain 3. Source

Date Code(counting from left to right) :
 1st code: year code, the last digit of Christian year
 2nd code : month code, Jan→A, Feb→B, Mar→C, Apr→D,
 May→E, Jun→F, Jul→G, Aug→H, Sep→J,
 Oct→K, Nov→L, Dec→M
 3rd and 4th codes : production serial number, 01~99

DIM	Inches		Millimeters		DIM	Inches		Millimeters	
	Min.	Max.	Min.	Max.		Min.	Max.	Min.	Max.
A	0.1732	0.1811	4.40	4.60	F	0.0591	TYP	1.50	TYP
B	0.1551	0.1673	3.94	4.25	G	0.1181	TYP	3.00	TYP
C	0.0610	REF	1.55	REF	H	0.0551	0.0630	1.40	1.60
D	0.0906	0.1024	2.30	2.60	I	0.0138	0.0173	0.35	0.44
E	0.0126	0.0205	0.32	0.52					